

SM1A20NSV-VB Datasheet

N-Channel 100 V (D-S) MOSFET

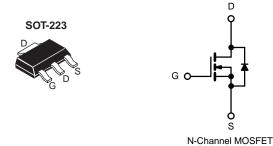
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
100	0.036 at V _{GS} = 10 V	6.4	23 nC			
100	0.0375 at V _{GS} = 8 V	5.5	23110			

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Extremely Low Q_{gd} for Switching Losses
- 100 % R_g Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
Parameter	Symbol Limit		Unit		
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C T _C = 70 °C	-	6.4 5.1		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C		5.5 ^{b, c} 4.5 ^{b, c}		
T _A = 70 °C Pulsed Drain Current		I _{DM}	26	Α	
Continuous Source-Drain Diode Current	T _C = 25 °C T _A = 25 °C	I _S	4.5 2.6 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy		E _{AS}	20	mJ	
	T _C = 25 °C		5.9		
Maximum Power Dissipation	T _C = 70 °C	P _D	3.8	W	
	T _A = 25 °C	C 'D 3.1 ^{b, c}	3.1 ^{b, c}		
	T _A = 70 °C	1 –	2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	33	40	°C/W		
Maximum Junction-to-Foot (Drain) Steady State		R _{thJF}	17	21	0/11		

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.



RoHS COMPLIANT HALOGEN FREE Available



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	- 1					•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			172		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 10			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.5		4.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Casta Maltana Duain Command		V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	DSS	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 55 °C			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			A	
Durin Courses On State Desistence		$V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		0.036		-	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 8 V, I_D = 5 A$		0.0375		Ω	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 5 A		23		S	
Dynamic ^b				·		•	
Input Capacitance	C _{iss}			1735			
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		160		pF	
Reverse Transfer Capacitance	C _{rss}			37			
Tatal Cata Charge		$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		28.5	43	43 35 nC	
Total Gate Charge	Q _g			23	35		
Gate-Source Charge	Q _{qs}	$V_{DS} = 75 \text{ V}, V_{GS} = 8 \text{ V}, I_{D} = 5 \text{ A}$		8			
Gate-Drain Charge	Q _{qd}			6.5			
Gate Resistance	R _g	f = 1 MHz		0.85	1.3	Ω	
Turn-on Delay Time	t _{d(on)}			14	21	- ns	
Rise Time	t _r	V_{DD} = 50 V, R_{L} = 10 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, \text{R}_g = 1 \Omega$		22	33		
Fall Time	t _f			6	10		
Turn-On Delay Time	t _{d(on)}			16	24		
Rise Time	t _r	V_{DD} = 50 V, R_{L} = 10 Ω		12	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$		20	30		
Fall Time	t _f			7	12	1	
Drain-Source Body Diode Characteristi				·			
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			7.7	А	
Pulse Diode Forward Current ^a	I _{SM}				50		
Body Diode Voltage	V_{SD}	I _S = 2.6 A		0.77	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			63	95	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			110	165	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		49			
Reverse Recovery Rise Time	t _b			14		ns	

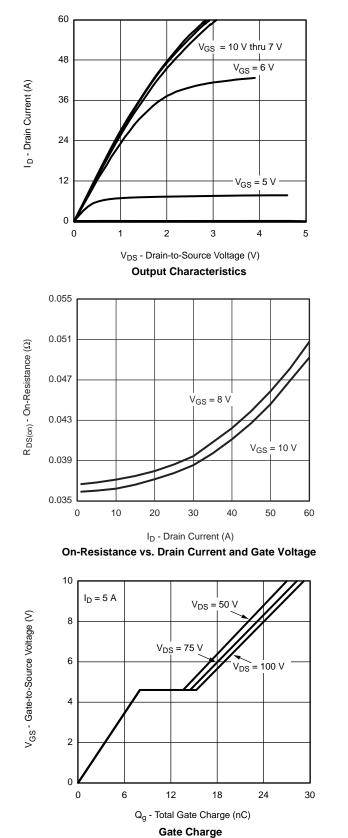
Notes:

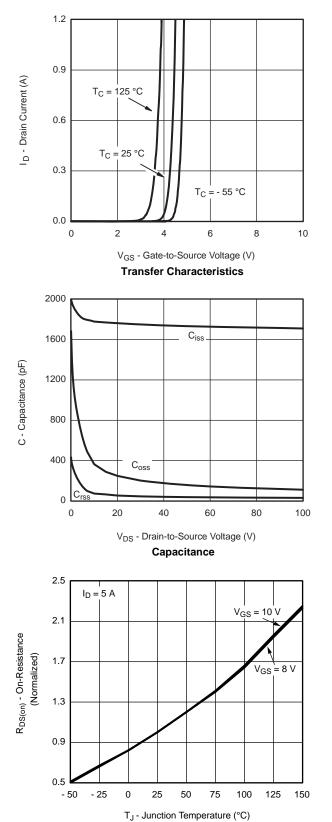
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$

a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

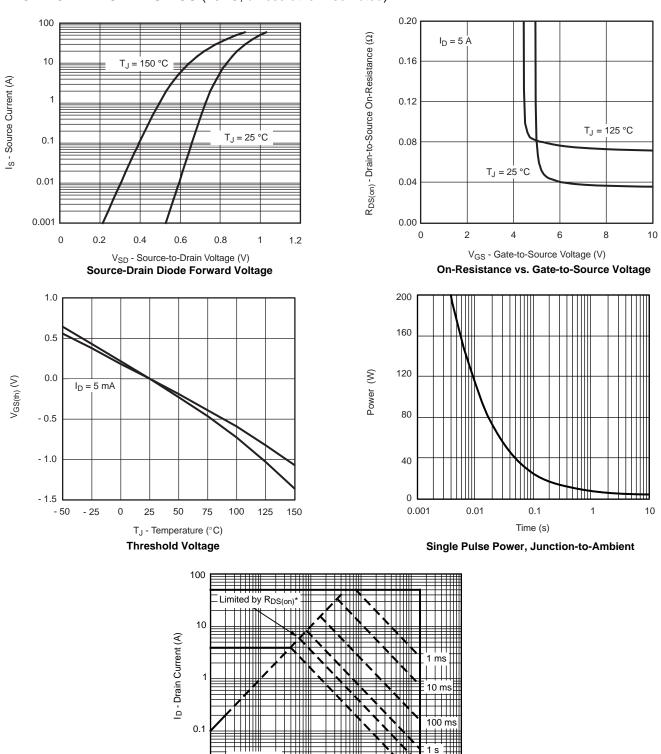


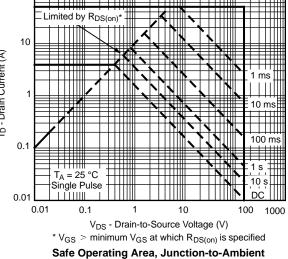




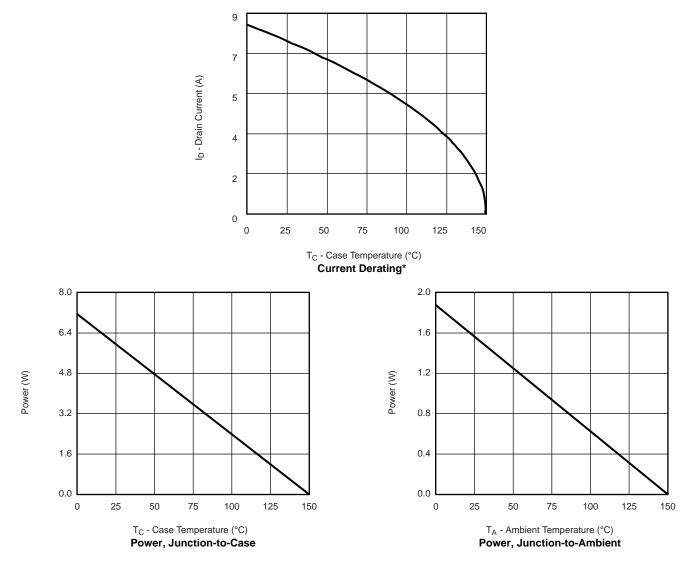
On-Resistance vs. Junction Temperature





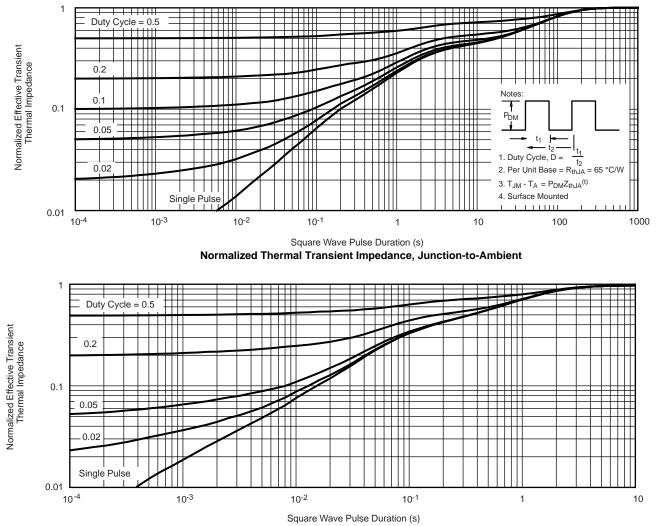






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



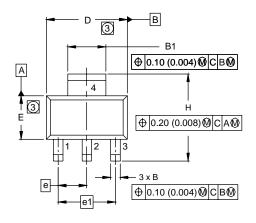


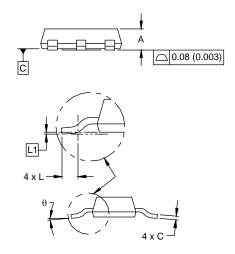
Normalized Thermal Transient Impedance, Junction-to-Foot

SM1A20NSV-VB



SOT-223





	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905 BSC		
e1	4.60 BSC		0.181 BSC		
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	-	
L1	0.061 BSC		0.0024 BSC		
θ	-	10'	-	10'	
ECN: S-82109-Rev. A, 15 DWG: 5969	-Sep-08		·		

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension do not include mold flash.

4. Outline conforms to JEDEC outline TO-261AA.



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